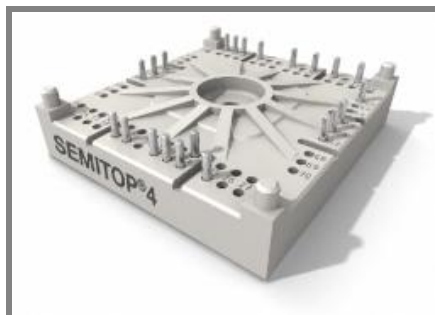


# SK 50 DGDL 126 T



**SEMITOP®4**

**3-phase bridge rectifier +  
brake chopper + 3-phase  
bridge inverter**  
**SK 50 DGDL 126 T**

Target Data

## Features

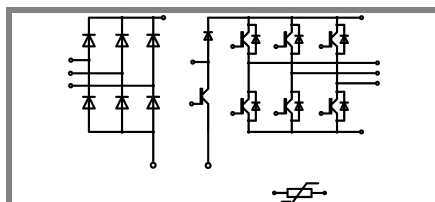
- One screw mounting module
- Fully compatible with SEMITOP®1,2,3
- Improved thermal performances by aluminium oxide substrate
- Trench IGBT technology
- CAL technology free-wheeling diode
- Integrated NTC temperature sensor

## Typical Applications

- Inverter up to 28 kVA
- Typ. motor power 15 kW

1)  $V_{ce,sat}$ ,  $V_f$  = chip level value

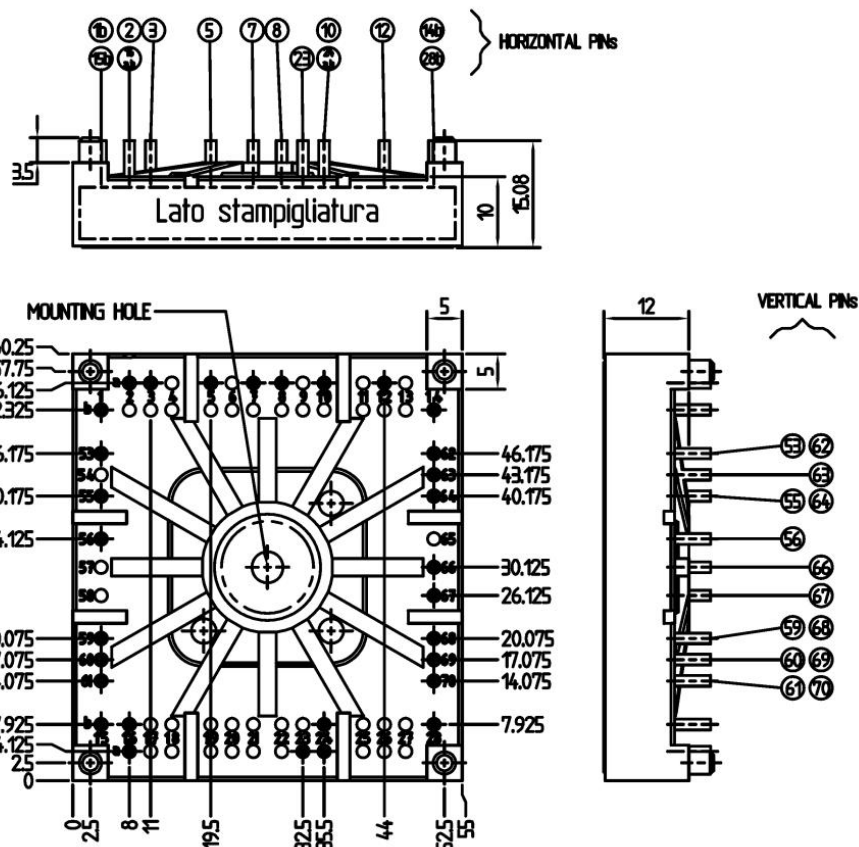
2) For IGBT chopper diagrams please refer to SK35DGDL126T



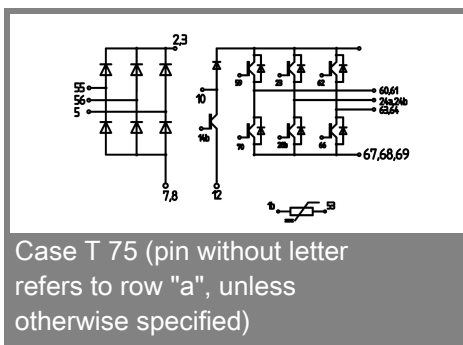
DGDL - T

Absolute Maximum Ratings		Ts = 25 °C, unless otherwise specified	
Symbol	Conditions	Values	Units
<b>IGBT - Inverter. For IGBT chopper maximum ratings, please refer to SK35DGDL126T</b>			
$V_{CES}$		1200	V
$I_C$	$T_s = 25 (70) ^\circ C$	68 (52)	A
$I_{CM}$	$T_s = 25 (70) ^\circ C$ , $t_p \leq 1$ ms	136 (104)	A
$V_{GES}$		$\pm 20$	V
$T_j$		-40 ... +150	$^\circ C$
<b>Diode - Inverter,Chopper</b>			
$I_F$	$T_s = 25 (70) ^\circ C$	62 (46)	A
$I_{FM} = -I_{CM}$	$T_s = 25 (70) ^\circ C$ , $t_p \leq 1$ ms	124 (92)	A
$T_j$		-40 ... +150	$^\circ C$
<b>Rectifier</b>			
$V_{RRM}$		1600	V
$I_F$	$T_s = 70 ^\circ C$	45	A
$I_{FSM} / I_{TSM}$	$t_p = 10$ ms, $\sin 180 ^\circ$ , $T_j = 25 ^\circ C$	700	A
$I_t^2$	$t_p = 10$ ms, $\sin 180 ^\circ$ , $T_j = 25 ^\circ C$	2400	A <sup>2</sup> s
$T_j$		-40 ... +150	$^\circ C$
$T_{sol}$	Terminals, 10 s	260	$^\circ C$
$T_{stg}$		-40 ... +125	$^\circ C$
$V_{isol}$	AC, 1 min. / 1 s	2500 / 3000	V

Characteristics		Ts = 25 °C, unless otherwise specified			
Symbol	Conditions	min.	typ.	max.	Units
IGBT - Inverter. For IGBT chopper electrical characteristics, please refer to SK35DGD126T					
V <sub>CEsat</sub>	I <sub>C</sub> = 50 A, T <sub>j</sub> = 25 (125) °C		1,7 (2)	2,15 (2,45)	V
V <sub>GE(th)</sub>	V <sub>GE</sub> = V <sub>CE</sub> , I <sub>C</sub> = 2 mA	5	5,8	6,5	V
V <sub>CE(TO)</sub>	T <sub>j</sub> = 25 °C (125) °C		1 (0,9)	1,2 (1,1)	V
r <sub>T</sub>	T <sub>j</sub> = 25 °C (125) °C		14 (22)	19 (27)	mΩ
C <sub>ies</sub>	V <sub>CE</sub> = 25 V <sub>GE</sub> = 0 V, f = 1 MHz		-		nF
C <sub>oes</sub>	V <sub>CE</sub> = 25 V <sub>GE</sub> = 0 V, f = 1 MHz		-		nF
C <sub>res</sub>	V <sub>CE</sub> = 25 V <sub>GE</sub> = 0 V, f = 1 MHz		-		nF
R <sub>th(j-s)</sub>	per IGBT		0,6		K/W
t <sub>d(on)</sub>	under following conditions		-		ns
t <sub>r</sub>	V <sub>CC</sub> = 600 V, V <sub>GE</sub> = ± 15 V		-		ns
t <sub>d(off)</sub>	I <sub>C</sub> = 50 A, T <sub>j</sub> = 125 °C		-		ns
t <sub>f</sub>	R <sub>Gon</sub> = R <sub>Goff</sub> = 12 Ω		-		ns
E <sub>on</sub>	inductive load		6,5		mJ
E <sub>off</sub>			6		mJ
Diode - Inverter,Chopper					
V <sub>F</sub> = V <sub>EC</sub>	I <sub>F</sub> = 50 A, T <sub>j</sub> = 25 (125) °C		1,35 (1,35)		V
V <sub>(TO)</sub>	T <sub>j</sub> = 25 °C (125) °C		0,95 (0,85)		V
r <sub>T</sub>	T <sub>j</sub> = 25 °C (125) °C		8 (10)		mΩ
R <sub>th(j-s)</sub>	per diode		1		K/W
I <sub>RRM</sub>	under following conditions		-		A
Q <sub>rr</sub>	I <sub>F</sub> = A, V <sub>R</sub> = V		-		μC
E <sub>rr</sub>	V <sub>GE</sub> = 0 V, T <sub>j</sub> = 125 °C				mJ
	di <sub>F</sub> /dt = - A/μs				
Diode - Rectifier					
V <sub>F</sub>	I <sub>F</sub> = 35 A, T <sub>j</sub> = 25 °C		1,1		V
V <sub>(TO)</sub>	T <sub>j</sub> = 150 °C		0,8		V
r <sub>T</sub>	T <sub>j</sub> = 150 °C		11		mΩ
R <sub>th(j-s)</sub>	per diode		0,9		K/W
Temperatur sensor					
R <sub>ts</sub>	5 %, T <sub>r</sub> = 25 (100 ) °C		5000(493)		Ω
Mechanical data					
w			60		g
M <sub>s</sub>	Mounting torque		3,5		Nm



Case T 75



This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX.

This technical information specifies semiconductor devices but promises no characteristics. No warranty or guarantee expressed or implied is made regarding delivery, performance or suitability.